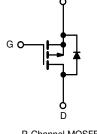




**Power MOSFET** 

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-200				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = -10 V 0.50				
Q <sub>g</sub> max. (nC)	44				
Q <sub>gs</sub> (nC)	7.1				
Q <sub>gd</sub> (nC)	27				
Configuration	Single				





P-Channel MOSFET

#### **FEATURES**

- Dynamic dV/dt rating
- Repetitive avalanche rated
- P-channel
- Fast switching
- Ease of paralleling
- · Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

#### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lood (Ph) free	IRF9640PbF		
Lead (Pb)-free	SiHF9640-E3		
SnPb	IRF9640		
	SiHF9640		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	-200	V
Gate-Source Voltage			V <sub>GS</sub>	± 20	V
Continuous Drain Current	V === 10.V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	-11	
Continuous Drain Current	V <sub>GS</sub> at -10 V	T <sub>C</sub> = 100 °C		-6.8	А
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	-44		
Linear Derating Factor				1.0	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	700	mJ
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	-11	A
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			P <sub>D</sub>	125	W
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	-5.0	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering Recommendations (Peak temperature) <sup>d</sup> for 10 s				300	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in
Mounting Torque				1.1	N·m

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. V<sub>DD</sub> = -50 V, starting T<sub>J</sub> = 25 °C, L = 8.7 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = -11 A (see fig. 12). c. I<sub>SD</sub>  $\leq$  -11 A, dl/dt  $\leq$  150 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C. d. 1.6 mm from case.

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-		<u>.</u>		1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = -250 μA	-200	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = -1 mA	-	-0.2	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = -250 μΑ	-2.0	-	-4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 V$	-	-	± 100	nA
Zeurs Oete Malta es Duris Ouwent		V <sub>DS</sub> =	-200 V, V <sub>GS</sub> = 0 V	-	-	-100	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -160 V	V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	-500	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -6.6 A <sup>b</sup>	-	-	0.50	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	-50 V, I <sub>D</sub> = -6.6 A <sup>b</sup>	4.1	-	-	S
Dynamic		•			•	•	-
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	1200	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = -25 V,$	-	370	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	81	-	
Total Gate Charge	Qg		V <sub>GS</sub> = -10 V I <sub>D</sub> = -11 A, V <sub>DS</sub> = -160 V, see fig. 6 and 13 <sup>b</sup>		-	44	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = -10 V			-	7.1	
Gate-Drain Charge	Q <sub>gd</sub>		See lig. 6 and 16	-	-	27	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = -100 V, I_D = -11 A $R_g$ = 9.1 $\Omega,~R_D$ = 8.6 $\Omega,~see$ fig. 10 $^{\rm b}$		-	14	-	- ns
Rise Time	t <sub>r</sub>			-	43	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	39	-	
Fall Time	t <sub>f</sub>			-	38	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	nH
Internal Source Inductance	L <sub>S</sub>	package and die contact	package and center of		7.5	-	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.3	-	1.7	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	-11	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse		-	-	-44	
Body Diode Voltage	V <sub>SD</sub>	$T_{J} = 25 \text{ °C}, I_{S} = -11 \text{ A}, V_{GS} = 0 \text{ V} \text{ b}$		-	-	-5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			-	250	300	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_{\rm J} = 25 ^{\circ}\text{C}, I_{\rm F} = -11 \text{A}, \text{dI/dt} = 100 \text{A/}\mu\text{s}^{\text{b}}$		-	2.9	3.6	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

#### Notes

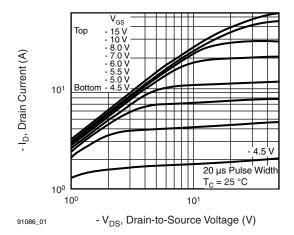
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

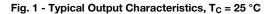
b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





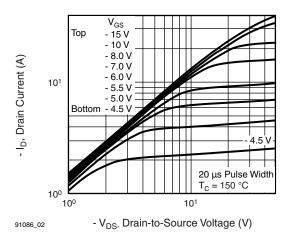
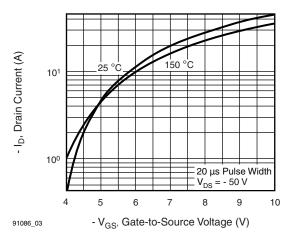


Fig. 2 - Typical Output Characteristics,  $T_C = 150 \ ^\circ C$ 





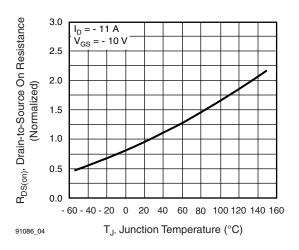


Fig. 4 - Normalized On-Resistance vs. Temperature

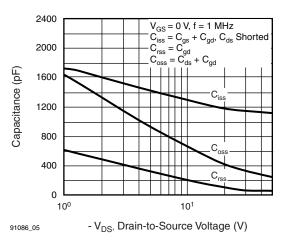


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

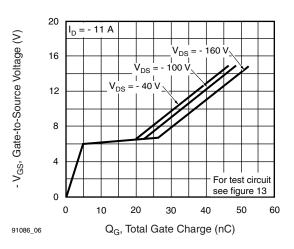


Fig. 6 - Typical Gate Charge vs. Drain-to-Source Voltage

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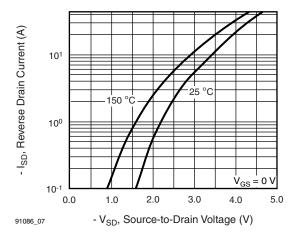


Fig. 7 - Typical Source-Drain Diode Forward Voltage

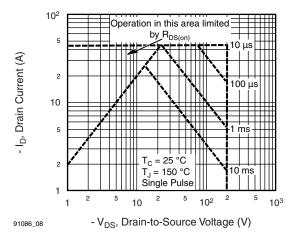


Fig. 8 - Maximum Safe Operating Area

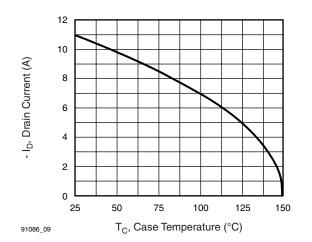


Fig. 9 - Maximum Drain Current vs. Case Temperature

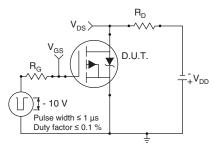


Fig. 10a - Switching Time Test Circuit

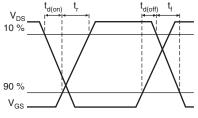
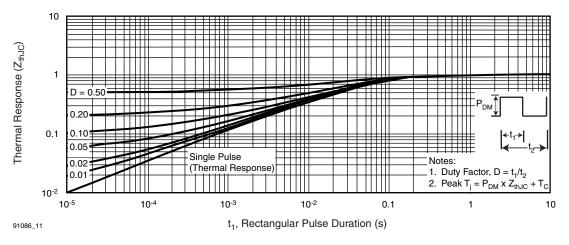


Fig. 10b - Switching Time Waveforms





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# IRF9640, SiHF9640

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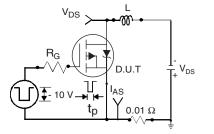


Fig. 12a - Unclamped Inductive Test Circuit

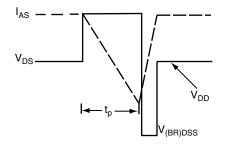


Fig. 12b - Unclamped Inductive Waveforms

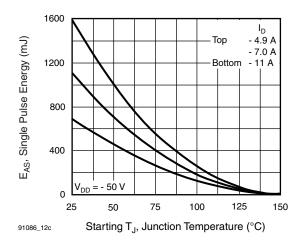


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

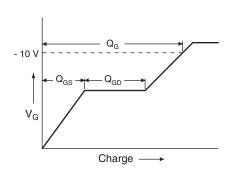


Fig. 13a - Basic Gate Charge Waveform

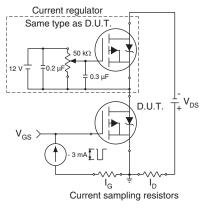


Fig. 13b - Gate Charge Test Circuit

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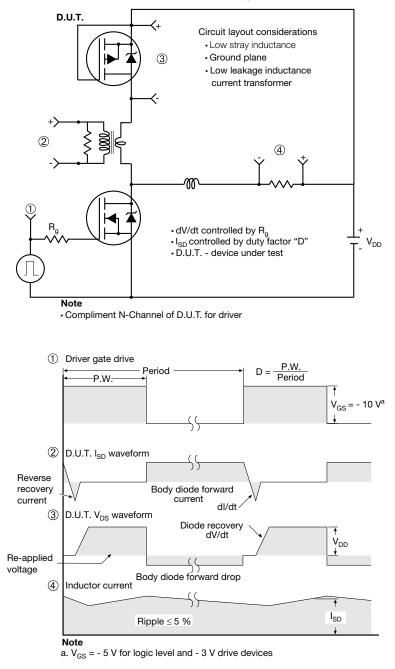


Fig. 14 - For P-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
ASE		Xi'an		
		IRF 9510 744K AB		

Revison: 14-Dec-15

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